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Understanding Embedded - CPLDs (Complex Programmable Logic Devices)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

Applications of Embedded - CPLDs

Details	
Product Status	Obsolete
Programmable Type	In-System Reprogrammable™ (ISR™) CMOS
Delay Time tpd(1) Max	10 ns
Voltage Supply - Internal	4.75V ~ 5.25V
Number of Logic Elements/Blocks	-
Number of Macrocells	32
Number of Gates	-
Number of I/O	37
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	44-LQFP
Supplier Device Package	44-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/cy37032p44-125axc

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The buried macrocell also supports input register capability. The buried macrocell can be configured to act as an input register (D-type or latch) whose input comes from the I/O pin associated with the neighboring macrocell. The output of all buried macrocells is sent directly to the PIM regardless of its configuration.

I/O Macrocell

Figure 2 illustrates the architecture of the I/O macrocell. The I/O macrocell supports the same functions as the buried macrocell with the addition of I/O capability. At the output of the macrocell, a polarity control mux is available to select active LOW or active HIGH signals. This has the added advantage of allowing significant logic reduction to occur in many applications.

The Ultra37000 macrocell features a feedback path to the PIM separate from the I/O pin input path. This means that if the macrocell is buried (fed back internally only), the associated I/O pin can still be used as an input.

Bus Hold Capabilities on all I/Os

Bus-hold, which is an improved version of the popular internal pull-up resistor, is a weak latch connected to the pin that does not degrade the device's performance. As a latch, bus-hold maintains the last state of a pin when the pin is placed in a high-impedance state, thus reducing system noise in bus-interface applications. Bus-hold additionally allows unused device pins to remain unconnected on the board, which is particularly useful during prototyping as designers can route new signals to the device without cutting trace connections to $V_{\rm CC}$ or GND. For more information, see the application note $Understanding\ Bus-Hold—A\ Feature\ of\ Cypress\ CPLDs$.

Programmable Slew Rate Control

Each output has a programmable configuration bit, which sets the output slew rate to fast or slow. For designs concerned with meeting FCC emissions standards the slow edge provides for lower system noise. For designs requiring very high performance the fast edge rate provides maximum system performance.

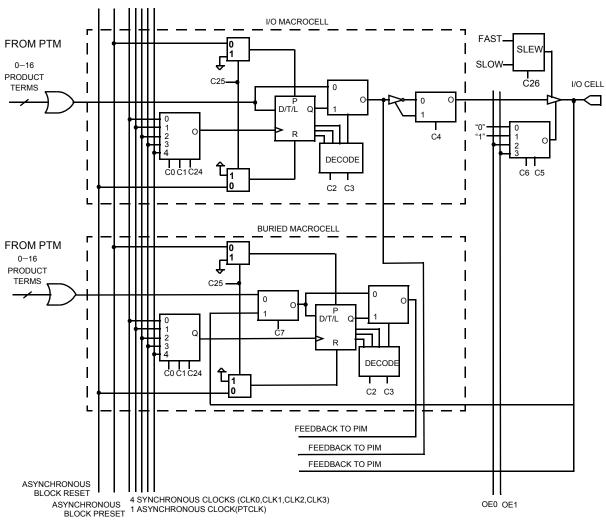


Figure 2. I/O and Buried Macrocells





Ultra37000 CPLD Family

resources for pinout flexibility, and a simple timing model for consistent system performance.

REGISTERED SIGNAL

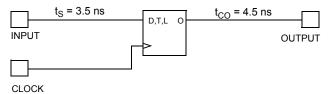


Figure 5. Timing Model for CY37128

JTAG and PCI Standards

PCI Compliance

5V operation of the Ultra37000 is fully compliant with the PCI Local Bus Specification published by the PCI Special Interest Group. The 3.3V products meet all PCI requirements except for the output 3.3V clamp, which is in direct conflict with 5V tolerance. The Ultra37000 family's simple and predictable timing model ensures compliance with the PCI AC specifications independent of the design.

IEEE 1149.1-compliant JTAG

The Ultra37000 family has an IEEE 1149.1 JTAG interface for both Boundary Scan and ISR.

Boundary Scan

The Ultra37000 family supports Bypass, Sample/Preload, Extest, Idcode, and Usercode boundary scan instructions. The JTAG interface is shown in *Figure 6*.

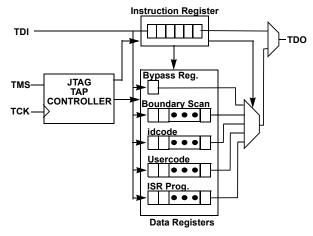


Figure 6. JTAG Interface

In-System Reprogramming (ISR)

In-System Reprogramming is the combination of the capability to program or reprogram a device on-board, and the ability to support design changes without changing the system timing or device pinout. This combination means design changes during debug or field upgrades do not cause board respins. The Ultra37000 family implements ISR by providing a JTAG compliant interface for on-board programming, robust routing

Development Software Support

Warp

Warp is a state-of-the-art compiler and complete CPLD design tool. For design entry, Warp provides an IEEE-STD-1076/1164 VHDL text editor, an IEEE-STD-1364 Verilog text editor, and a graphical finite state machine editor. It provides optimized synthesis and fitting by replacing basic circuits with ones pre-optimized for the target device, by implementing logic in unused memory and by perfect communication between fitting and synthesis. To facilitate design and debugging, Warp provides graphical timing simulation and analysis.

Warp Professional™

Warp Professional contains several additional features. It provides an extra method of design entry with its graphical block diagram editor. It allows up to 5 ms timing simulation instead of only 2 ms. It allows comparison of waveforms before and after design changes.

Warp Enterprise™

Warp Enterprise provides even more features. It provides unlimited timing simulation and source-level behavioral simulation as well as a debugger. It has the ability to generate graphical HDL blocks from HDL text. It can even generate testbenches.

Warp is available for PC and UNIX platforms. Some features are not available in the UNIX version. For further information see the Warp for PC, Warp for UNIX, Warp Professional and Warp Enterprise data sheets on Cypress's web site (www.cypress.com).

Third-Party Software

Although *Warp* is a complete CPLD development tool on its own, it interfaces with nearly every third party EDA tool. All major third-party software vendors provide support for the Ultra37000 family of devices. Refer to the third-party software data sheet or contact your local sales office for a list of currently supported third-party vendors.

Programming

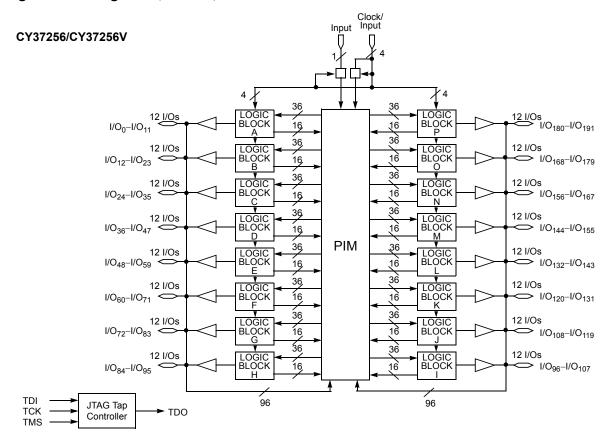
There are four programming options available for Ultra37000 devices. The first method is to use a PC with the 37000 UltraISR programming cable and software. With this method, the ISR pins of the Ultra37000 devices are routed to a connector at the edge of the printed circuit board. The 37000 UltraISR programming cable is then connected between the parallel port of the PC and this connector. A simple configuration file instructs the ISR software of the programming operations to be performed on each of the Ultra37000 devices in the system. The ISR software then automatically completes all of the necessary data manipulations required to accomplish the programming, reading, verifying, and other ISR functions. For more information on the Cypress ISR Interface, see the ISR Programming Kit data sheet (CY3700i).

The second method for programming Ultra37000 devices is on automatic test equipment (ATE). This is accomplished through a file created by the ISR software. Check the Cypress website for the latest ISR software download information.





Logic Block Diagrams (continued)







Ultra37000 CPLD Family

5.0V Device Characteristics Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.) Storage Temperature-65°C to +150°C

Ambient Temperature with

Power Applied55°C to +125°C

Supply Voltage to Ground Potential -0.5V to +7.0V

DC Voltage Applied to Outputs	0.5)/45.17.0)/
in High-Z State	–0.5V to +7.0V
DC Input Voltage	0.5V to +7.0V
DC Program Voltage	4.5 to 5.5V
Current into Outputs	16 mA
Static Discharge Voltage(per MIL-STD-883, Method 3015)	> 2001V
Latch-up Current	> 200 mA

Operating Range^[2]

Range	Ambient Temperature ^[2]	Junction Temperature	Output Condition	V _{cc}	V _{cco}
Commercial	0°C to +70°C	0°C to +90°C	5V	5V ± 0.25V	5V ± 0.25V
			3.3V	5V ± 0.25V	$3.3V \pm 0.3V$
Industrial	–40°C to +85°C	–40°C to +105°C	5V	5V ± 0.5V	5V ± 0.5V
			3.3V	$5V \pm 0.5V$	$3.3V\pm0.3V$
Military ^[3]	–55°C to +125°C	–55°C to +130°C	5V	$5V \pm 0.5V$	5V ± 0.5V
			3.3V	5V ± 0.5V	$3.3V\pm0.3V$

5.0V Device Electrical Characteristics Over the Operating Range

Parameter	Description	Test Cor	nditions	Min.	Тур.	Max.	Unit
V _{OH}	Output HIGH Voltage	V _{CC} = Min.	$I_{OH} = -3.2 \text{ mA (Com'l/Ind)}^{[4]}$	2.4			V
			$I_{OH} = -2.0 \text{ mA } (Mil)^{[4]}$	2.4			V
V _{OHZ}	Output HIGH Voltage with	V _{CC} = Max.	I _{OH} = 0 μA (Com'I) ^[6]			4.2	V
	Output Disabled ^[5]		$I_{OH} = 0 \mu A (Ind/Mil)^{[6]}$			4.5	V
			$I_{OH} = -100 \mu A (Com'I)^{[6]}$			3.6	V
			$I_{OH} = -150 \mu A (Ind/Mil)^{[6]}$			3.6	V
V_{OL}	Output LOW Voltage	V _{CC} = Min.	I _{OL} = 16 mA (Com'l/Ind) ^[4]			0.5	V
			I _{OL} = 12 mA (Mil) ^[4]			0.5	V
V _{IH}	Input HIGH Voltage	Guaranteed Input Logical HIG	2.0		V_{CCmax}	V	
V_{IL}	Input LOW Voltage	Guaranteed Input Logical LO	W Voltage for all Inputs ^[7]	-0.5		0.8	V
I _{IX}	Input Load Current	V_I = GND OR V_{CC} , Bus-Hold	-10		10	μА	
I _{OZ}	Output Leakage Current	V_O = GND or V_{CC} , Output Di	sabled, Bus-Hold Disabled	-50		50	μА
Ios	Output Short Circuit Current ^[5,8]	V_{CC} = Max., V_{OUT} = 0.5V		-30		-160	mA
I _{BHL}	Input Bus-Hold LOW Sustaining Current	V _{CC} = Min., V _{IL} = 0.8V		+75			μА
Івнн	Input Bus-Hold HIGH Sustaining Current	V _{CC} = Min., V _{IH} = 2.0V		-75			μА
I _{BHLO}	Input Bus-Hold LOW Overdrive Current	V _{CC} = Max.				+500	μА
Івнно	Input Bus-Hold HIGH Overdrive Current	V _{CC} = Max.				-500	μА

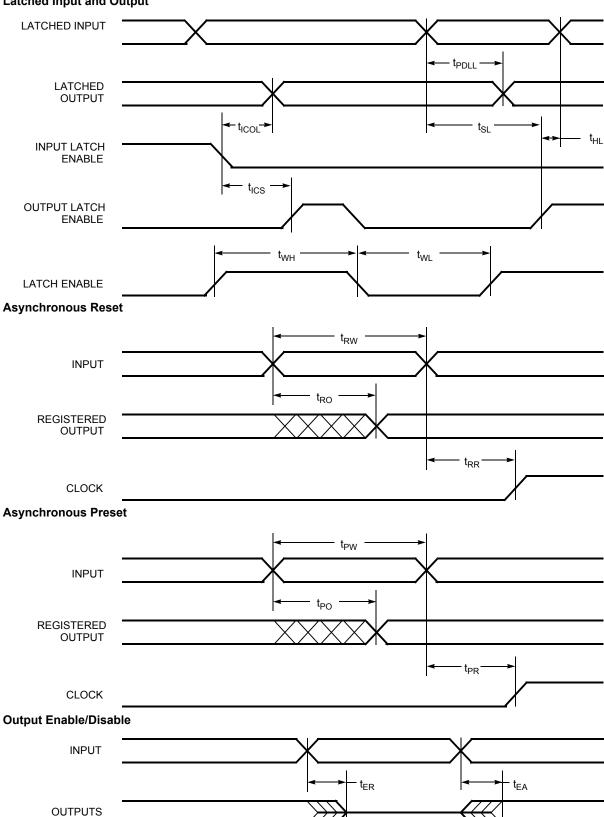
- Normal Programming Conditions apply across Ambient Temperature Range for specified programming methods. For more information on programming the Ultra37000 Family devices, please refer to the Application Note titled "An Introduction to In System Reprogramming with the Ultra37000."
- 3. TA is the "Instant On" case temperature.
- 4. I_{OH} = -2 mA, I_{OL} = 2 mA for TDO.
 5. Tested initially and after any design or process changes that may affect these parameters.
- When the I/O is output disabled, the bus-hold circuit can weakly pull the I/O to above 3.6V if no leakage current is allowed. Note that all I/Os are output disabled during ISR programming. Refer to the application note "Understanding Bus-Hold" for additional information.
- These are absolute values with respect to device ground. All overshoots due to system or tester noise are included.
- Not more than one output should be tested at a time. Duration of the short circuit should not exceed 1 second. V_{OUT} = 0.5V has been chosen to avoid test problems caused by tester ground degradation.





Switching Waveforms (continued)

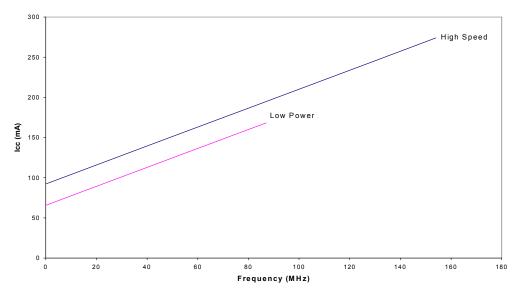
Latched Input and Output





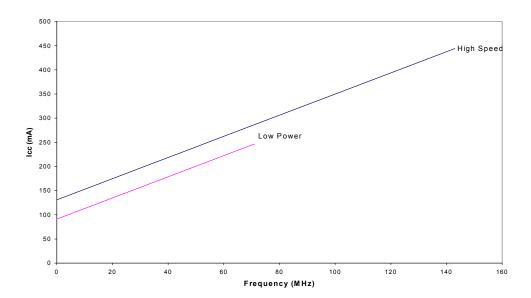


Typical 5.0V Power Consumption (continued) **CY37256**



The typical pattern is a 16-bit up counter, per logic block, with outputs disabled. $V_{CC} = 5.0V,\, T_A = Room \, Temperature$

CY37384

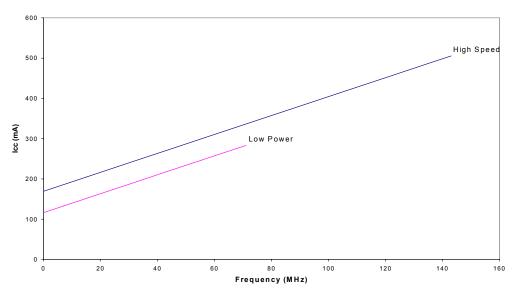


The typical pattern is a 16-bit up counter, per logic block, with outputs disabled. $V_{CC} = 5.0V,\, T_A = Room\, Temperature$



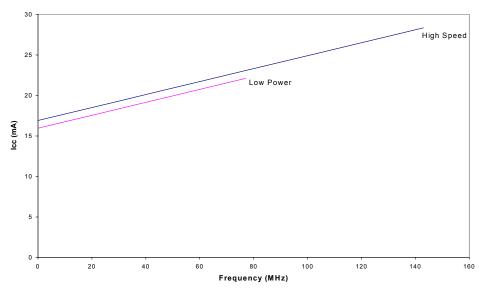


Typical 5.0V Power Consumption (continued) **CY37512**



The typical pattern is a 16-bit up counter, per logic block, with outputs disabled. $V_{CC} = 5.0V, \, T_A = Room \, Temperature$

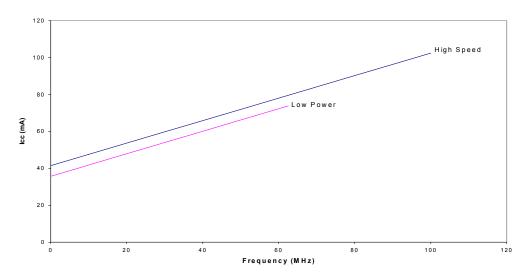
Typical 3.3V Power Consumption CY37032V



The typical pattern is a 16-bit up counter, per logic block, with outputs disabled. $V_{CC} = 3.3V,\, T_A = Room\, Temperature$

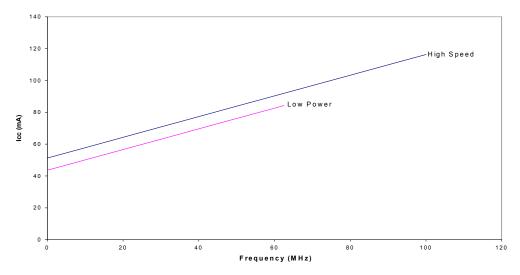


Typical 3.3V Power Consumption (continued) **CY37192V**



The typical pattern is a 16-bit up counter, per logic block, with outputs disabled. $V_{\rm CC}$ = 3.3V, $T_{\rm A}$ = Room Temperature

CY37256V



The typical pattern is a 16-bit up counter, per logic block, with outputs disabled. $V_{\rm CC} = 3.3V,\,T_A = Room\,Temperature$





Pin Configurations^[20] (continued)

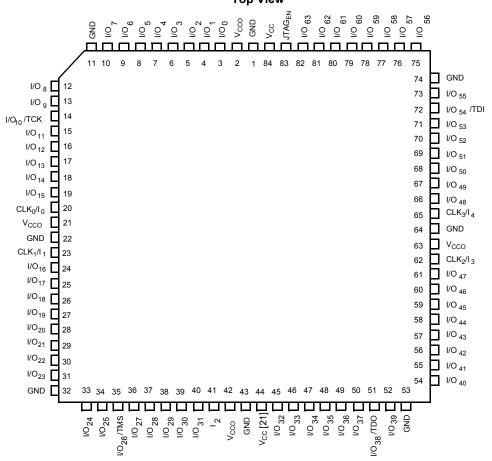
48-ball Fine-Pitch BGA (BA50) Top View

8

I/O₃ I/O₁ I/O₃₀ I/O₅ TCK V_{cc} I/O₃₁ V_{CC} I/O₂₇ TDI V_{CC} I/O₀ CLK₁/ I₄ CLK₂/I₀ I/O₇ GND GND С I/O₆ I/O₂₅ I/O₂₄ I_3 CLK₃/ I₂ JTAG_{EN} GND GND I/O₂₃ D I/O₈ I/O₉ I/O₂₂ CLK₀/ I₁ I/O₁₂ I/O₁₁ I/O₁₀ I/O₁₆ I/O₂₀ V_{CC} I/O₁₄ I/O₁₅ I/O₁₇ I/O₁₈ I/O₁₃ TMS I/O₁₉ TDO

Note: 20. For 3.3V versions (Ultra37000V), $V_{CCO} = V_{CC}$.

84-lead PLCC (J83) / CLCC (Y84) Top View



Note:

21. This pin is a N/C, but Cypress recommends that you connect it to V_{CC} to ensure future compatibility.





Pin Configurations^[20] (continued)

256-Ball Fine-Pitch BGA (BB256) Top View

	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
Α	GND	GND	I/O ₂₆	I/O ₂₄	I/O ₂₀	V _{CC}	I/O ₁₁	GND	GND	I/O ₁₈₆	V _{CC}	I/O ₁₇₇	I/O ₁₇₂	I/O ₁₆₇	GND	GND
В	GND	I/O ₂₇	I/O ₂₅	I/O ₂₃	I/O ₁₉	I/O ₁₅	I/O ₁₀	GND	GND	I/O ₁₈₅	I/O ₁₈₁	I/O ₁₇₆	I/O ₁₇₁	I/O ₁₆₆	I/O ₁₆₅	GND
С	I/O ₂₉	I/O ₂₈	NC	I/O ₂₂	I/O ₁₈	I/O ₁₄	I/O ₉	I/O ₄	I/O ₁₉₁	I/O ₁₈₄	I/O ₁₈₀	I/O ₁₇₅	I/O ₁₇₀	NC	I/O ₁₆₃	I/O ₁₆₄
D	I/O ₃₂	I/O ₃₁	I/O ₃₀	NC	I/O ₁₇	I/O ₁₃	I/O ₈	I/O ₃	I/O ₁₉₀	I/O ₁₈₃	I/O ₁₇₉	I/O ₁₇₄	I/O ₁₆₉	I/O ₁₆₀	I/O ₁₆₁	I/O ₁₆₂
E	I/O ₃₅	I/O ₃₄	I/O ₃₃	I/O ₂₁	I/O ₁₆	I/O ₁₂	I/O ₇	I/O ₂	I/O ₁₈₉	V _{CC}	I/O ₁₇₈	I/O ₁₇₃	I/O ₁₆₈	I/O ₁₅₇	I/O ₁₅₈	I/O ₁₅₉
F	V _{CC}	I/O ₃₈	I/O ₃₇	I/O ₃₆	TCK	V _{CC}	I/O ₆	I/O ₁	I/O ₁₈₈	I/O ₁₈₂	V _{CC}	TDI	I/O ₁₅₄	I/O ₁₅₅	I/O ₁₅₆	V _{CC}
G	I/O ₄₃	I/O ₄₂	I/O ₄₁	I/O ₄₀	V _{CC}	I/O ₃₉	I/O ₅	I/O ₀	I/O ₁₈₇	I/O ₁₄₈	I/O ₁₄₉	CLK ₃ /I ₄	I/O ₁₅₀	I/O ₁₅₁	I/O ₁₅₂	I/O ₁₅₃
Н	GND	GND	I/O ₄₇	I/O ₄₆	CLK ₀ /I ₀	I/O ₄₅	I/O ₄₄	GND	GND	I/O ₁₄₄	I/O ₁₄₅	CLK ₂ /I ₃	I/O ₁₄₆	I/O ₁₄₇	GND	GND
J	GND	GND	I/O ₅₁	I/O ₅₀	NC	I/O ₄₉	I/O ₄₈	GND	GND	I/O ₁₄₀	I/O ₁₄₁	l ₂	I/O ₁₄₂	I/O ₁₄₃	GND	GND
K	I/O ₅₇	I/O ₅₆	I/O ₅₅	I/O ₅₄	CLK ₁	I/O ₅₃	I/O ₅₂	I/O ₉₁	I/O ₉₆	I/O ₁₀₁	I/O ₁₃₅	V _{CC}	I/O ₁₃₆	I/O ₁₃₇	I/O ₁₃₈	I/O ₁₃₉
L	V _{CC}	I/O ₆₀	I/O ₅₉	I/O ₅₈	TMS	V _{CC}	I/O ₈₆	I/O ₉₂	I/O ₉₇	I/O ₁₀₂	V _{CC}	TDO	I/O ₁₃₂	I/O ₁₃₃	I/O ₁₃₄	V _{CC}
M	I/O ₆₃	I/O ₆₂	I/O ₆₁	I/O ₇₂	I/O ₇₇	I/O ₈₂	V _{CC}	I/O ₉₃	I/O ₉₈	I/O ₁₀₃	I/O ₁₀₈	I/O ₁₁₂	I/O ₁₁₇	I/O ₁₂₉	I/O ₁₃₀	I/O ₁₃₁
N	I/O ₆₆	I/O ₆₅	I/O ₆₄	I/O ₇₃	I/O ₇₈	I/O ₈₃	I/O ₈₇	I/O ₉₄	I/O ₉₉	I/O ₁₀₄	I/O ₁₀₉	I/O ₁₁₃	NC	I/O ₁₂₆	I/O ₁₂₇	I/O ₁₂₈
Р	I/O ₆₈	I/O ₆₇	NC	I/O ₇₄	I/O79	I/O ₈₄	I/O ₈₈	I/O ₉₅	I/O ₁₀₀	I/O ₁₀₅	I/O ₁₁₀	I/O ₁₁₄	I/O ₁₁₈	NC	I/O ₁₂₄	I/O ₁₂₅
R	GND	I/O ₆₉	I/O ₇₀	I/O ₇₅	I/O ₈₀	I/O ₈₅	I/O ₈₉	GND	GND	I/O ₁₀₆	I/O ₁₁₁	I/O ₁₁₅	I/O ₁₁₉	I/O ₁₂₁	I/O ₁₂₃	GND
Т	GND	GND	I/O ₇₁	I/O ₇₆	I/O ₈₁	V _{CC}	I/O ₉₀	GND	GND	I/O ₁₀₇	V _{CC}	I/O ₁₁₆	I/O ₁₂₀	I/O ₁₂₂	GND	GND



Ultra37000 CPLD Family

3.3V Ordering Information (continued)

Macrocells	Speed (MHz)	Ordering Code	Package Name	Package Type	Operating Range
64	143	CY37064VP44-143AC	A44	44-Lead Thin Quad Flatpack	Commercial
		CY37064VP44-143AXC	A44	44-Lead Lead Free Thin Quad Flatpack	
		CY37064VP48-143BAC	BA50	48-Ball Fine-Pitch Ball Grid Array	
		CY37064VP100-143AC	A100	100-Lead Thin Quad Flatpack	
		CY37064VP100-143AXC	A100	100-Lead Lead Free Thin Quad Flatpack	
		CY37064VP100-143BBC	BB100	100-Ball Fine-Pitch Ball Grid Array	
	100	CY37064VP44-100AC	A44	44-Lead Thin Quad Flatpack	Commercia
		CY37064VP44-100AXC	A44	44-Lead Lead Free Thin Quad Flatpack	
		CY37064VP48-100BAC	BA50	48-Ball Fine-Pitch Ball Grid Array	
		CY37064VP100-100AC	A100	100-Lead Thin Quad Flatpack	
		CY37064VP100-100AXC	A100	100-Lead Lead Free Thin Quad Flatpack	
		CY37064VP100-100BBC	BB100	100-Ball Fine-Pitch Ball Grid Array	
		CY37064VP44-100AI	A44	44-Lead Thin Quad Flatpack	Industrial
		CY37064VP44-100AXI	A44	44-Lead Lead Free Thin Quad Flatpack	
		CY37064VP48-100BAI	BA50	48-Ball Fine-Pitch Ball Grid Array	
		CY37064VP100-100BBI	BB100	100-Ball Fine-Pitch Ball Grid Array	
		CY37064VP100-100AI	A100	100-Lead Thin Quad Flatpack	
		CY37064VP100-100AXI	A100	100-Lead Lead Free Thin Quad Flatpack	
		5962-9952001QYA	Y67	44-Lead Ceramic Leaded Chip Carrier	Military
128	125	CY37128VP100-125AC	A100	100-Lead Thin Quad Flat Pack	Commercia
		CY37128VP100-125AXC	A100	100-Lead Lead Free Thin Quad Flat Pack	
		CY37128VP100-125BBC	BB100	100-Ball Fine-Pitch Ball Grid Array	
		CY37128VP160-125AC	A160	160-Lead Thin Quad Flat Pack	
		CY37128VP160-125AXC	A160	160-Lead Lead Free Thin Quad Flat Pack	
		CY37128VP160-125AI	A160	160-Lead Thin Quad Flat Pack	Industrial
		CY37128VP160-125AXI	A160	160-Lead Lead Free Thin Quad Flat Pack	
	83	CY37128VP100-83AC	A100	100-Lead Thin Quad Flat Pack	Commercia
		CY37128VP100-83AXC	A100	100-Lead Lead Free Thin Quad Flat Pack	
		CY37128VP100-83BBC	BB100	100-Ball Fine-Pitch Ball Grid Array	
		CY37128VP160-83AC	A160	160-Lead Thin Quad Flat Pack	
		CY37128VP160-83AXC	A160	160-Lead Lead Free Thin Quad Flat Pack	
		CY37128VP100-83AI	A100	100-Lead Thin Quad Flat Pack	Industrial
		CY37128VP100-83AXI	A100	100-Lead Lead Free Thin Quad Flat Pack	
		CY37128VP100-83BBI	BB100	100-Ball Fine-Pitch Ball Grid Array	
		CY37128VP160-83AI	A160	160-Lead Thin Quad Flat Pack	
		CY37128VP160-83AXI	A160	160-Lead Lead Free Thin Quad Flat Pack	
		5962-9952201QYA	Y84	84-Lead Ceramic Leaded Chip Carrier	Military
192	100	CY37192VP160-100AC	A160	160-Lead Thin Quad Flat Pack	Commercia
		CY37192VP160-100AXC	A160	160-Lead Lead Free Thin Quad Flat Pack	
	66	CY37192VP160-66AC	A160	160-Lead Thin Quad Flat Pack	Commercia
		CY37192VP160-66AXC	A160	160-Lead Lead Free Thin Quad Flat Pack	
		CY37192VP160-66AI	A160	160-Lead Thin Quad Flat Pack	Industrial
		013/182VF 100-00AI	A100	100-Leau Tiiii Quau Flat Fack	inuusinal



Ultra37000 CPLD Family

3.3V Ordering Information (continued)

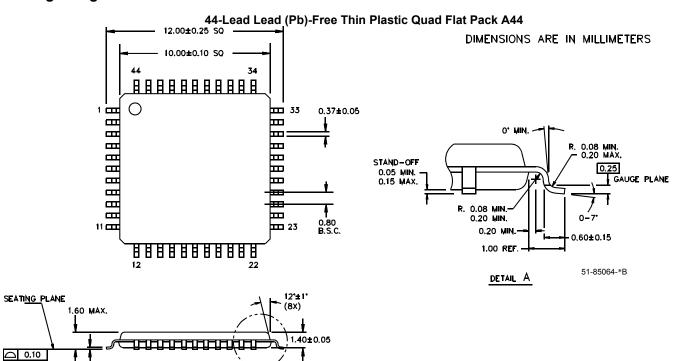
Macrocells	Speed (MHz)	Ordering Code	Package Name	Package Type	Operating Range
256	100	CY37256VP160-100AC	A160	160-Lead Thin Quad Flat Pack	Commercial
		CY37256VP160-100AXC	A160	160-Lead Lead Free Thin Quad Flat Pack	
		CY37256VP208-100NC	N208	208-Lead Plastic Quad Flat Pack	
		CY37256VP256-100BGC	BG292	292-Ball Plastic Ball Grid Array	
		CY37256VP256-100BBC	BB256	256-Ball Fine-Pitch Ball Grid Array	
		CY37256VP160-100AI	A160	160-Lead Thin Quad Flat Pack	Industrial
		CY37256VP160-100AXI	A160	160-Lead Lead Free Thin Quad Flat Pack	
	66	CY37256VP160-66AC	A160	160-Lead Thin Quad Flat Pack	Commercial
		CY37256VP160-66AXC	A160	160-Lead Lead Free Thin Quad Flat Pack	
		CY37256VP208-66NC	N208	208-Lead Plastic Quad Flat Pack	
		CY37256VP256-66BGC	BG292	292-Ball Plastic Ball Grid Array	
		CY37256VP256-66BBC	BB256	256-Ball Fine-Pitch Ball Grid Array	
		CY37256VP160-66AI	A160	160-Lead Thin Quad Flat Pack	Industrial
		CY37256VP256-66BGI	BG292	292-Ball Plastic Ball Grid Array	
		CY37256VP256-66BBI	BB256	256-Ball Fine-Pitch Ball Grid Array	
		5962-9952401QZC	U162	160-Lead Ceramic Quad Flat Pack	Military
384	83	CY37384VP208-83NC	N208	208-Lead Plastic Quad Flat Pack	Commercial
		CY37384VP256-83BGC	BG292	292-Ball Plastic Ball Grid Array	
	66	CY37384VP208-66NC	N208	208-Lead Plastic Quad Flat Pack	Commercial
		CY37384VP256-66BGC	BG292	292-Ball Plastic Ball Grid Array	
		CY37384VP208-66NI	N208	208-Lead Plastic Quad Flat Pack	Industrial
		CY37384VP256-66BGI	BG292	292-Ball Plastic Ball Grid Array	
512	83	CY37512VP208-83NC	N208	208-Lead Plastic Quad Flat Pack	Commercial
		CY37512VP256-83BGC	BG292	292-Ball Plastic Ball Grid Array	
		CY37512VP352-83BGC	BG388	388-Ball Plastic Ball Grid Array	
		CY37512VP400-83BBC	BB400	400-Ball Fine-Pitch Ball Grid Array	
	66	CY37512VP208-66NC	N208	208-Lead Plastic Quad Flat Pack	Commercial
		CY37512VP256-66BGC	BG292	292-Ball Plastic Ball Grid Array	
		CY37512VP352-66BGC	BG388	388-Ball Plastic Ball Grid Array	
		CY37512VP400-66BBC	BB400	400-Ball Fine-Pitch Ball Grid Array	
		CY37512VP208-66NI	N208	208-Lead Plastic Quad Flat Pack	Industrial
		CY37512VP256-66BGI	BG292	292-Ball Plastic Ball Grid Array	
		CY37512VP352-66BGI	BG388	388-Ball Plastic Ball Grid Array	
		CY37512VP400-66BBI	BB400	400-Ball Fine-Pitch Ball Grid Array	
		5962-9952601QZC	U208	208-Lead Ceramic Quad Flat Pack	Military



0.20 MAX.

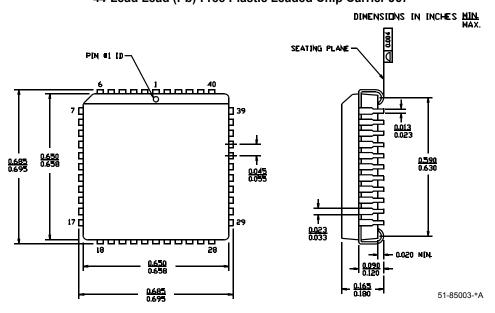


Package Diagrams



44-Lead Lead (Pb)-Free Plastic Leaded Chip Carrier J67

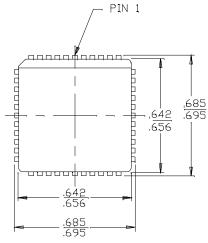
SEE DETAIL A

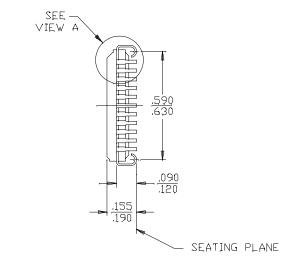


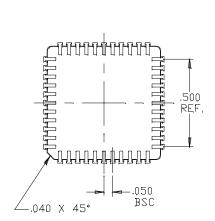


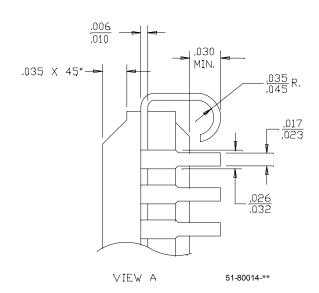


44-Lead Ceramic Leaded Chip Carrier Y67





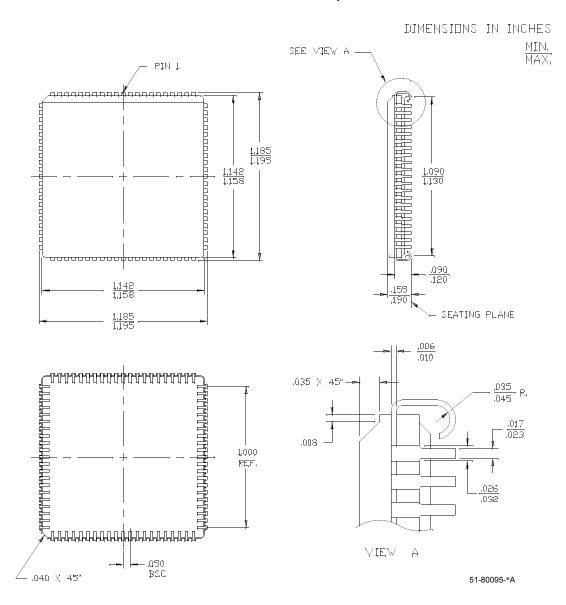








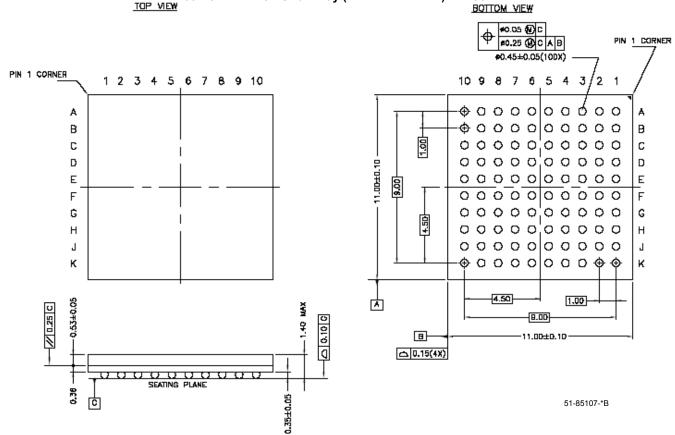
84-Lead Ceramic Leaded Chip Carrier Y84







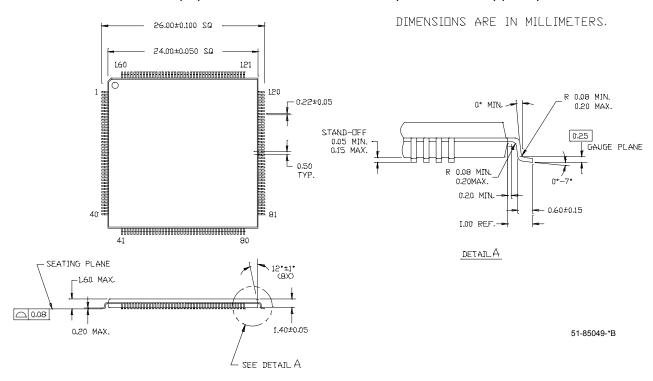
100-Ball Thin Ball Grid Array (11 x 11 x 1.4 mm) BB100





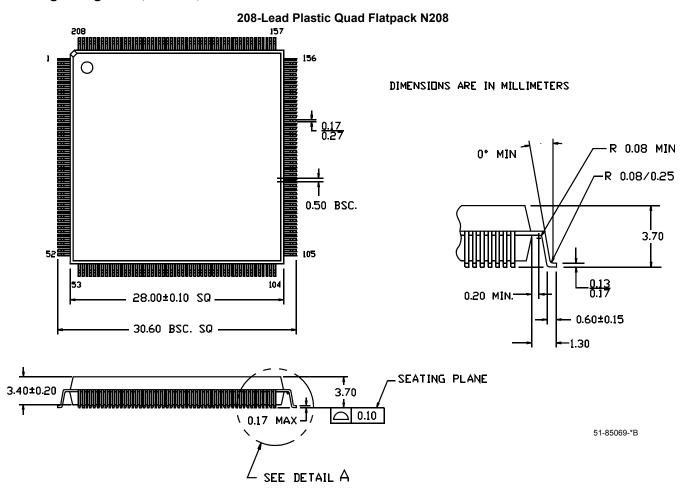


160-Lead Lead (Pb)-Free Thin Plastic Quad Flat Pack (24 x 24 x 1.4 mm) (TQFP) A160













Addendum

3.3V Operating Range

(CY37064VP100-143AC, CY37064VP100-143BBC, CY37064VP44-143AC, CY37064VP48-143BAC)

Range	Ambient Temperature ^[2] Junction Temperatu		V _{CC}	
Commercial	0°C to +70°C	0°C to +90°C	3.3V ± 0.16V	





Document History Page

	ment Title: L ment Numbe		LD Family	5V, 3.3V, ISR™ High-Performance CPLDs	
REV.	ECN NO.	Issue Date	Orig. of Change	Description of Change	
**	106272	04/18/01	SZV	Change from Spec number: 38-00475 to 38-03007	
*A	124942	03/21/03	OOR	Updated 3.3V V _{CC} requirements for –144 speeds Added an Addendum	
*B	126262	05/09/03	TEH	Changed pinout for CY37128V BB100 package	
*C	128125	07/16/03	НОМ	Obsoleted following 3.3V PLCC packaged devices: CY37032VP44-143JC CY37032VP44-100JC CY37064VP44-143JC CY37064VP84-143JC CY37064VP44-100JC CY37064VP84-100JC CY37064VP84-100JI CY37064VP84-100JI CY37128VP84-125JC CY37128VP84-83JI	
*D	282709	See ECN	YDT	Changed package diagrams and labels for consistency Added Lead (Pb)-free logo on first page, as well as a note in Features Added Lead (Pb)-free package diagram labels Added Lead-free Parts to Ordering Information CY37032P44-200AXC, CY37032P44-200JXC, CY37032P44-154AXI, CY37032P44-154JXI, CY37032P44-125AXC, CY37032P44-125JXC, CY37064P44-200AXC, CY37064P44-200JXC, CY37064P100-200AXC, CY37064P44-154JXI, CY37064P44-154JXI, CY37064P44-125AXC, CY37064P44-125JXC, CY37064P100-125AXC, CY37064P44-125AXI, CY37064P41-125JXC, CY37128P84-167JXC, CY37128P100-167AXC, CY37128P160-167AXC, CY37128P84-125JXI, CY37128P100-125AXI, CY37128P160-125AXI, CY37128P84-125JXI, CY37128P100-125AXI, CY37128P160-125AXI, CY37128P84-100JXC, CY37128P100-100AXC, CY37128P160-125AXI, CY37128P84-100JXC, CY37128P100-100AXC, CY37192P160-125AXC, CY37128P100-100AXI, CY37192P160-154AXC, CY37192P160-83AXI, CY37256P160-154AXC, CY37256P160-125AXI, CY37032VP44-143AXC, CY37032VP44-100AXC, CY37032VP44-100AXI, CY37032VP44-100JXI, CY37064VP100-100AXC, CY37064VP100-143AXC, CY37064VP44-100AXC, CY37064VP100-100AXC, CY37064VP44-100AXI, CY37064VP44-100AXI, CY37128VP100-83AXC, CY37128VP160-83AXC, CY37128VP160-125AXI, CY37128VP100-83AXI, CY37128VP160-125AXI, CY37128VP160-66AXC, CY37128VP100-83AXI, CY37128VP160-125AXI, CY37128VP100-83AXI, CY37128VP100-83AXI, CY37128VP160-100AXI, CY37128VP100-83AXI, CY37128VP100-83AXI, CY37128VP160-100AXI, CY37128VP160-66AXC, CY37256VP160-100AXC, CY37256VP160-100AXI, CY37256VP160-66AXC	
*E	321635	See ECN	PCX	Added Package Diagram BG292 Updated all PBGA package type information (BG292 & BG388)	